



General Description

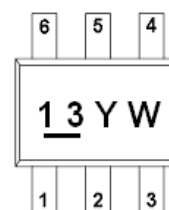
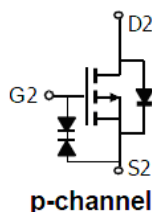
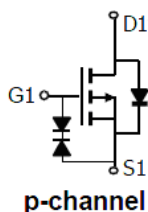
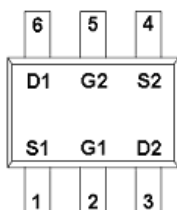
AFP1913E, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- -20V/-0.6A, $R_{DS(ON)} = 580 \text{ m}\Omega @ V_{GS} = -4.5\text{V}$
- -20V/-0.5A, $R_{DS(ON)} = 780 \text{ m}\Omega @ V_{GS} = -2.5\text{V}$
- -20V/-0.4A, $R_{DS(ON)} = 980 \text{ m}\Omega @ V_{GS} = -1.8\text{V}$
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation
- ESD Protection Diode design-in
- SOT-363 package design

Pin Description (SOT-363)



Application

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Load/Power Switching Smart Phones, Pagers
- PA Switch
- Level Switch

Pin Define

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	D2	Drain 2
4	S2	Source 2
5	G2	Gate 2
6	D1	Drain1

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFP1913ES36RG	13YW	SOT-363	Tape & Reel	3000 EA

- ※ 13 parts code
- ※ Y year code (0 ~ 9)
- ※ W week code (A ~ Z = 1 ~ 26 / a ~ z = 27 ~ 52)
- ※ AFP1913ES36RG : 7" Tape & Reel ; Pb- Free ; Halogen -Free



Absolute Maximum Ratings

($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	-20	V
Gate-Source Voltage	V_{GSS}	± 12	V
Continuous Drain Current($T_J=150^\circ\text{C}$)	I_D	$T_A=25^\circ\text{C}$	-1.4
		$T_A=70^\circ\text{C}$	-1.0
Pulsed Drain Current	I_{DM}	-6	A
Continuous Source Current(Diode Conduction)	I_S	-1	A
Power Dissipation	P_D	$T_A=25^\circ\text{C}$	0.3
		$T_A=70^\circ\text{C}$	0.2
Operating Junction Temperature	T_J	-55/150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55/150	$^\circ\text{C}$

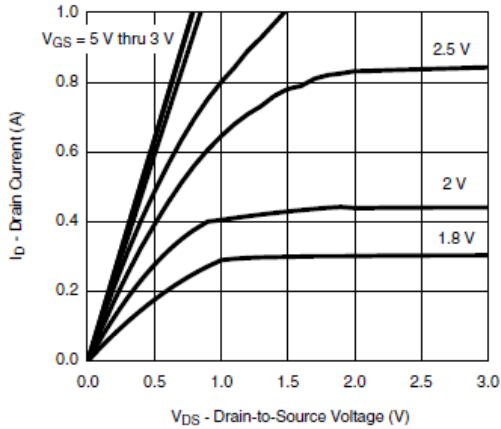
Electrical Characteristics

($T_A=25^\circ\text{C}$ Unless otherwise noted)

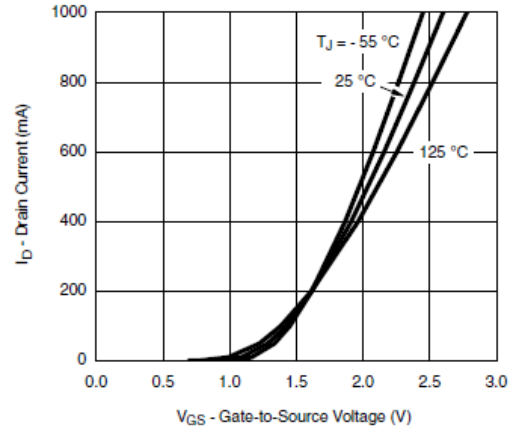
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu\text{A}$	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.4		-1.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$			± 5	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-14V, V_{GS}=0V$			-1	μA
		$V_{DS}=-14V, V_{GS}=0V$ $T_J=85^\circ\text{C}$			-5	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \geq 5V, V_{GS}=4.5V$	0.7			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-0.6A$		380	580	m Ω
		$V_{GS}=-2.5V, I_D=-0.5A$		540	780	
		$V_{GS}=-1.8V, I_D=-0.4A$		820	980	
Forward Transconductance	g_{FS}	$V_{DS}=-10V, I_D=-0.4A$		1		S
Diode Forward Voltage	V_{SD}	$I_S=-0.15A, V_{GS}=0V$		0.65	1.2	V
Dynamic						
Input Capacitance	C_{iss}	$V_{DS}=-10V, V_{GS}=0V$ $f=1\text{MHz}$		70	100	pF
Output Capacitance	C_{oss}			20		
Reverse Transfer Capacitance	C_{rss}			10		
Total Gate Charge	Q_g	$V_{DS}=-10V, V_{GS}=-4.5V$ $I_D \equiv -0.25A$		1.0	1.3	nC
Gate-Source Charge	Q_{gs}			0.1		
Gate-Drain Charge	Q_{gd}			0.3		
Turn-On Time	$t_{d(on)}$	$V_{DD}=-10V, R_L=30\Omega$ $I_D \equiv -0.2A, V_{GEN}=-4.5V$ $R_G=10\Omega$		10	15	ns
	t_r			10	15	
Turn-Off Time	$t_{d(off)}$			40	60	
	t_f			30	50	



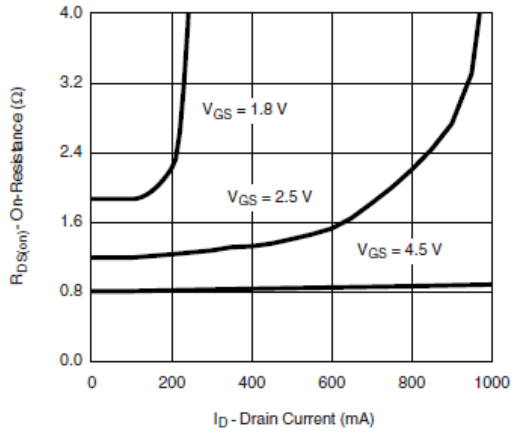
Typical Characteristics



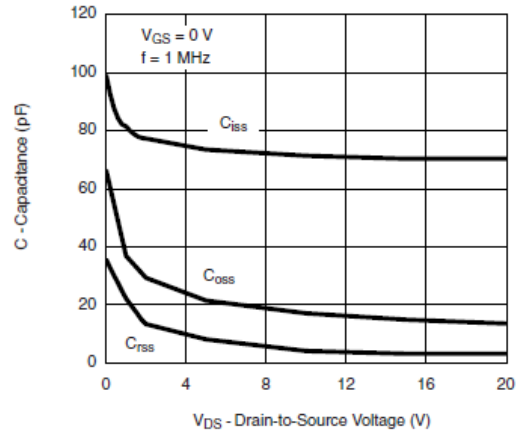
Output Characteristics



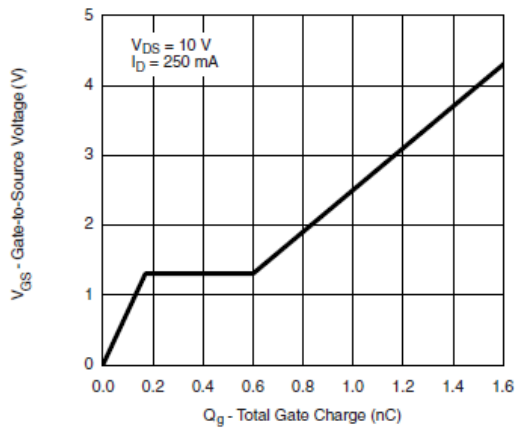
Transfer Characteristics



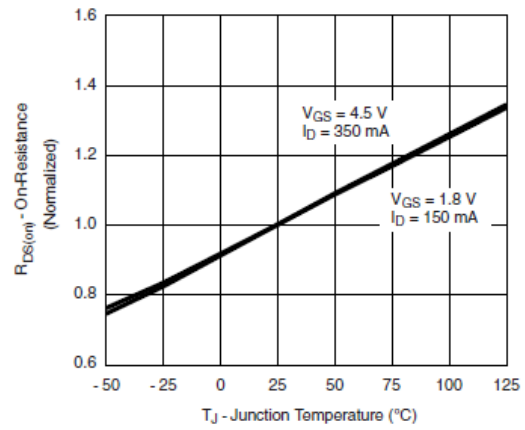
On-Resistance vs. Drain Current



Capacitance



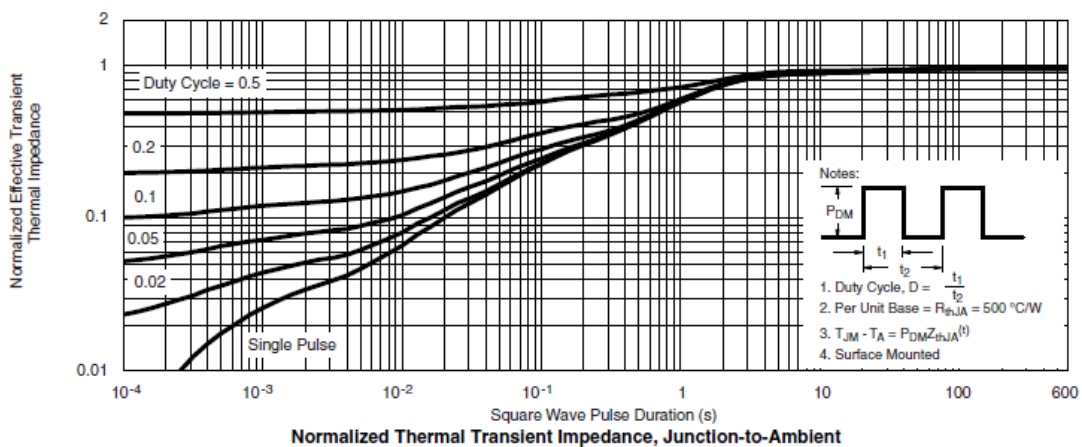
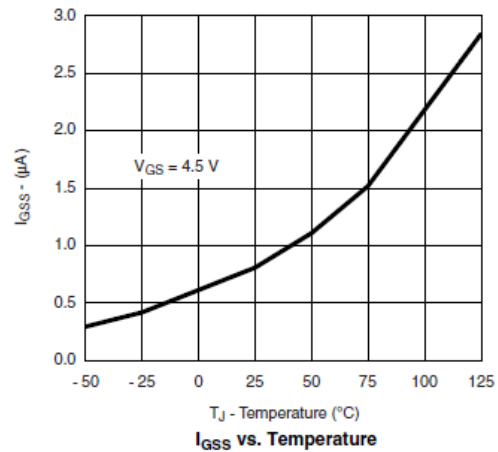
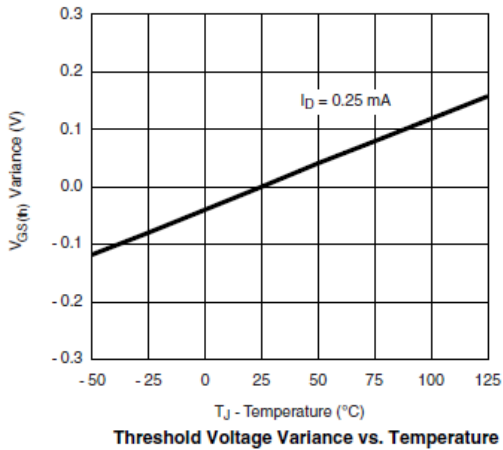
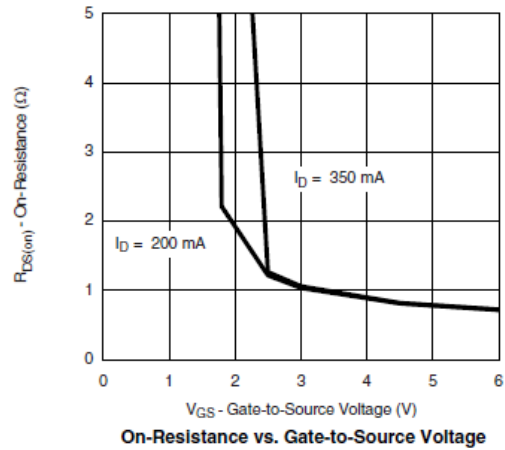
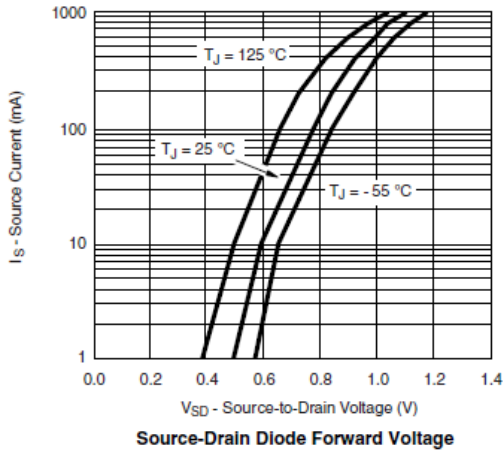
Gate Charge



On-Resistance vs. Junction Temperature



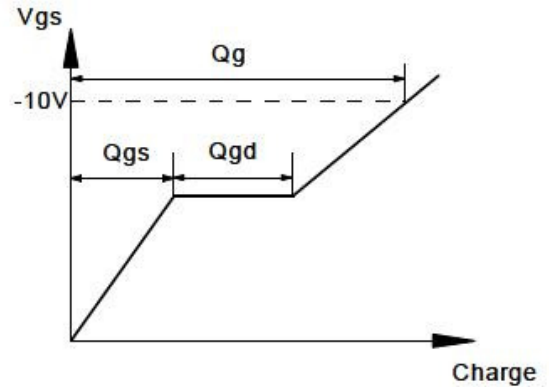
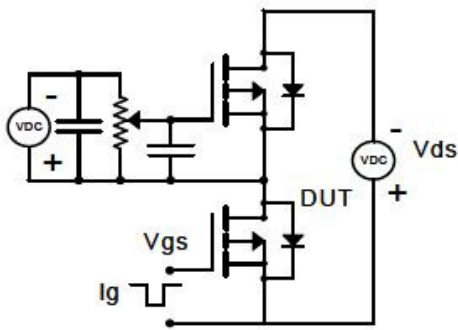
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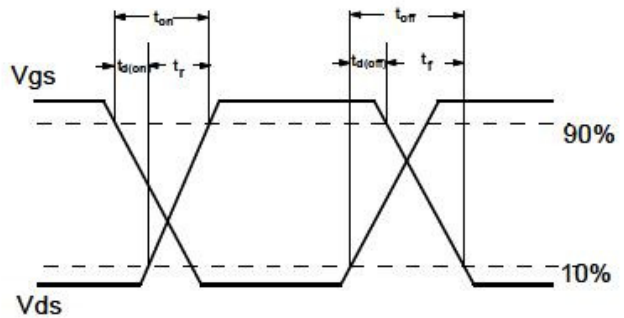
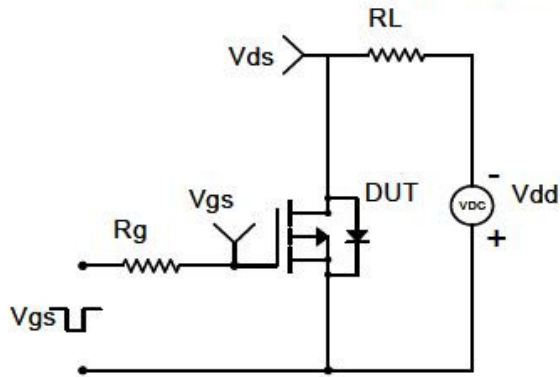


Typical Characteristics

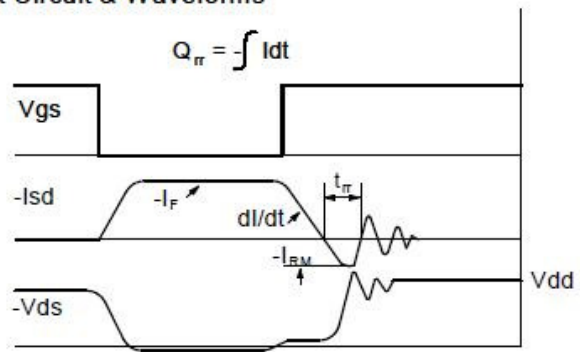
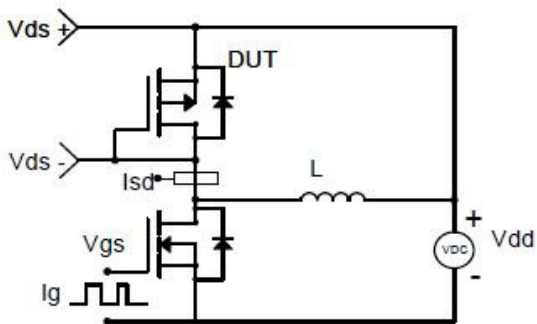
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

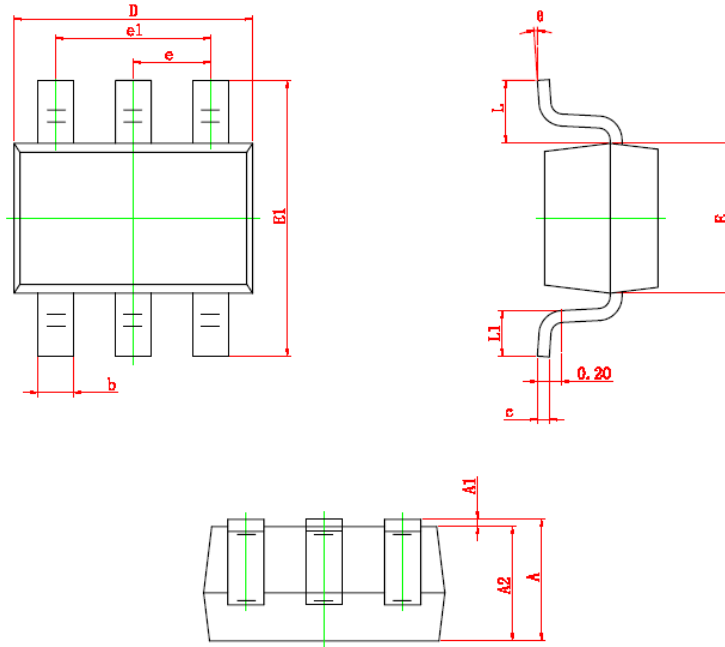


Diode Recovery Test Circuit & Waveforms





Package Information (SOT-363)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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